

DS3486

DS3486 Quad RS-422, RS-423 Line Receiver



Literature Number: SNLS354C

DS3486 Quad RS-422, RS-423 Line Receiver

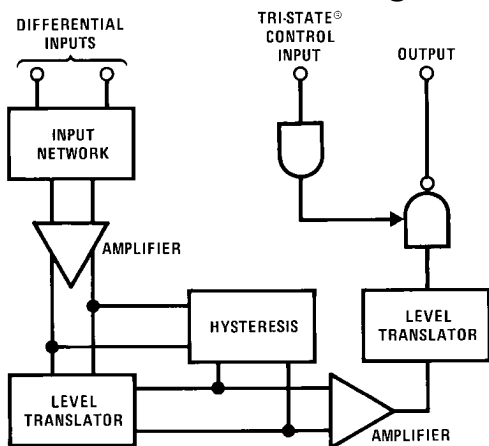
General Description

National's quad RS-422, RS-423 receiver features four independent receivers which comply with EIA Standards for the electrical characteristics of balanced/unbalanced voltage digital interface circuits. Receiver outputs are 74LS compatible, TRI-STATE® structures which are forced to a high impedance state when the appropriate output control pin reaches a logic zero condition. A PNP device buffers each output control pin to assure minimum loading for either logic one or logic zero inputs. In addition, each receiver has internal hysteresis circuitry to improve noise margin and discourage output instability for slowly changing input waveforms.

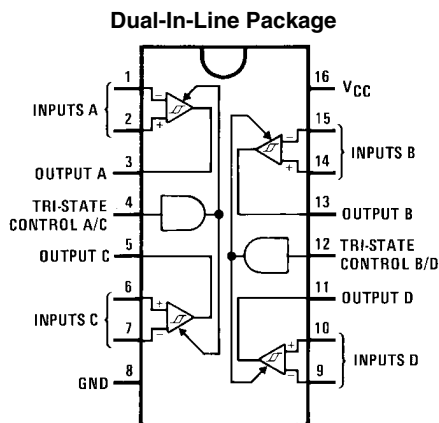
Features

- Four independent receivers
- TRI-STATE outputs
- Internal hysteresis –140 mV (typ)
- Fast propagation times –19 ns (typ)
- TTL compatible outputs
- 5V supply
- Pin compatible and interchangeable with MC3486

Block and Connection Diagrams



577901



577902

Top View
Order Number DS3486M or DS3486N
See NS Package Number M16A or N16E

Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Power Supply Voltage, V_{CC}	8V
Input Common-Mode Voltage, V_{ICM}	$\pm 25V$
Input Differential Voltage, V_{ID}	$\pm 25V$
TRI-STATE Control Input Voltage, V_I	8V
Output Sink Current, I_O	50 mA
Storage Temperature, T_{STG}	$-65^{\circ}C$ to $+150^{\circ}C$
Maximum Power Dissipation (Note 1) at $25^{\circ}C$	
Molded Dip Package	1362 mW

SO Package	1002 mW
SO Package Thermal Resistance	
θ_{JA}	$+124.5^{\circ}C/W$
θ_{JC}	$+41.2^{\circ}C/W$

Operating Conditions

	Max	Min	Units
Power Supply Voltage, V_{CC}	4.75	5.25	V
Operating Temperature, T_A	0	70	$^{\circ}C$
Input Common-Mode Voltage Range, V_{ICR}	-7.0	7.0	V

Note 1: Derate Dip molded package 10.2 mW/ $^{\circ}C$ above $25^{\circ}C$. Derate SO package 8.01 mW/ $^{\circ}C$ above $25^{\circ}C$.

Electrical Characteristics (Note 3)

(Unless otherwise noted, minimum and maximum limits apply over recommended temperature and power supply voltage ranges. Typical values are for $T_A = 25^{\circ}C$, $V_{CC} = 5V$ and $V_{IC} = 0V$.)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{IH}	Input Voltage—High Logic State (TRI-STATE Control)		2.0			V
V_{IL}	Input Voltage—Low Logic State (TRI-STATE Control)				0.8	V
$V_{TH(D)}$	Differential Input Threshold Voltage	$-7V \leq V_{IC} \leq 7V$, V_{IH} TRI-STATE = 2V $I_O = -0.4$ mA, $V_{OH} \geq 2.7V$		0.070	0.2	V
		$I_O = 8$ mA, $V_{OL} \geq 0.5V$		0.070	-0.2	V
$I_{IB(D)}$	Input Bias Current	$V_{CC} = 0V$ or $5.25V$, Other Inputs at $0V$				
		$V_I = -10V$			-3.25	mA
		$V_I = -3V$			-1.50	mA
		$V_I = 3V$			1.50	mA
		$V_I = 10V$			3.25	mA
	Input Balance	$-7V \leq V_{IC} \leq 7V$, $V_{IH(3C)} = 2V$, (Note 5)				
		V_{OH} $I_O = -0.4$ mA, $V_{ID} = 0.4V$	2.7			V
		V_{OL} $I_O = 8$ mA, $V_{ID} = -0.4V$			0.5	V
I_{OZ}	Output TRI-STATE Leakage Current	$V_{I(D)} = 3V$, $V_{IL} = 0.8V$, $V_{OL} = 0.5V$			-40	μA
		$V_{I(D)} = -3V$, $V_{IL} = 0.8V$, $V_{OH} = 2.7V$			40	μA
I_{OS}	Output Short-Circuit Current	$V_{I(D)} = 3V$, V_{IH} TRI-STATE = 2V, $V_O = 0V$, (Note 4)	-15		-100	mA
I_{IL}	Input Current—Low Logic State (TRI-STATE Control)	$V_{IL} = 0.5V$			-100	μA
I_{IH}	Input Current—High Logic State (TRI-STATE Control)	$V_{IH} = 2.7V$			20	μA
		$V_{IH} = 5.25V$			100	μA
V_{IC}	Input Clamp Diode Voltage (TRI-STATE Control)	$I_{IN} = -10$ mA			-1.5	V
I_{CC}	Power Supply Current	All Inputs $V_{IL} = 0V$			85	mA

Note 2: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 3: All currents into device pins are shown as positive, out of device pins are negative. All voltages referenced to ground unless otherwise noted.

Note 4: Only one output at a time should be shorted.

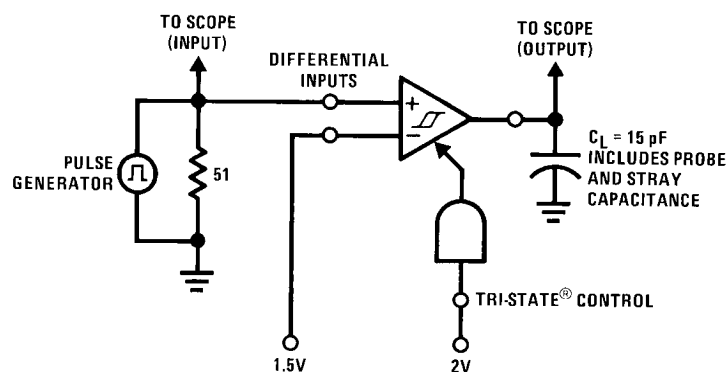
Note 5: Refer to EIA RS-422/3 for exact conditions.

Switching Characteristics

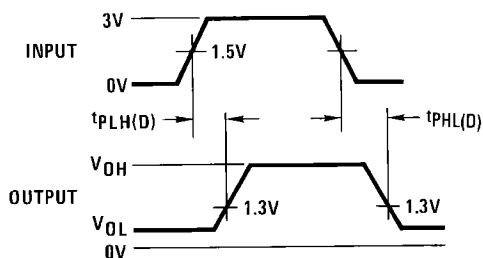
(Unless otherwise noted, $V_{CC} = 5V$ and $T_A = 25^\circ C$.)

Symbol	Parameter	Min	Typ	Max	Units
$t_{PHL(D)}$	Propagation Delay Time—Differential Inputs to Output Output High to Low		19	35	ns
$t_{PLH(D)}$	Output Low to High		19	30	ns
t_{PLZ}	TRI-STATE Control to Output Output Low to TRI-STATE		23	35	ns
t_{PHZ}	Output High to TRI-STATE		25	35	ns
t_{PZH}	Output TRI-STATE to High		18	30	ns
t_{PZL}	Output TRI-STATE to Low		20	30	ns

AC Test Circuit and Switching Time Waveforms



577903



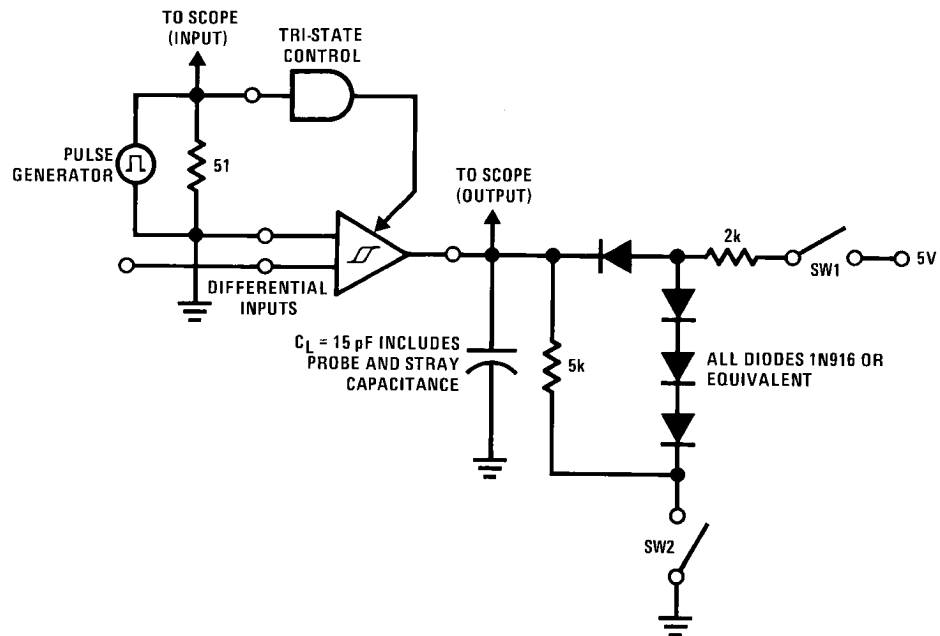
577904

Input pulse characteristics:

$t_{TLH} = t_{THL} = 6 \text{ ns}$ (10% to 90%)

PRR = 1 MHz, 50% duty cycle

FIGURE 1. Propagation Delay Differential Input to Output



577905

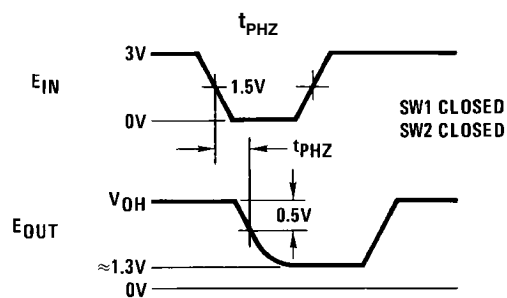
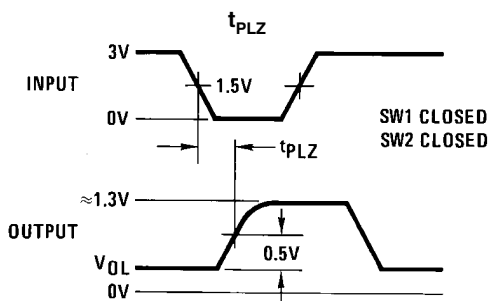
1.5V for t_{PHZ} and t_{PLZ}

1.5V for t_{PLZ} and t_{PZL}

Input pulse characteristics:

$t_{TLH} = t_{THL} = 6 \text{ ns}$ (10% to 90%)

PRR = 1 MHz, 50% duty cycle



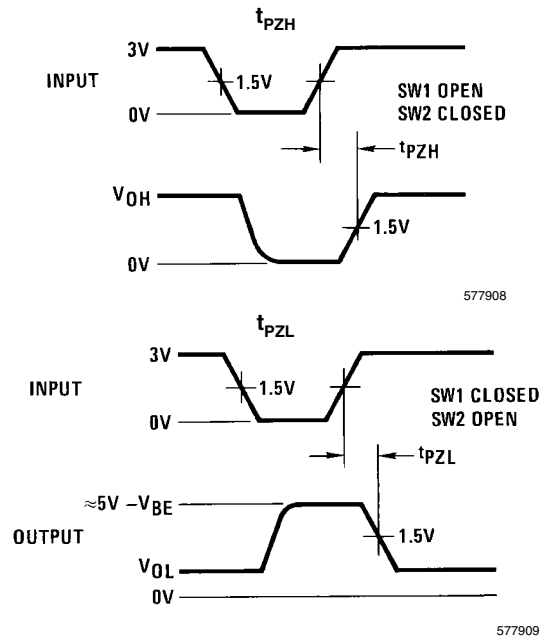
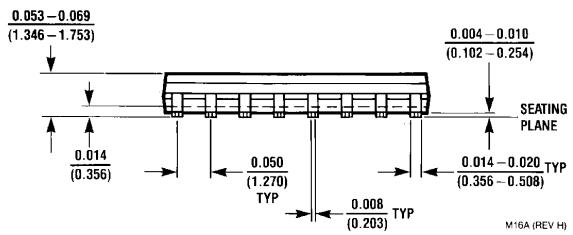
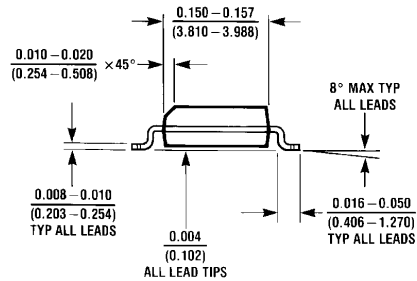
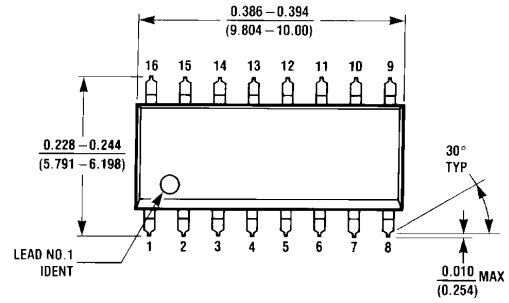


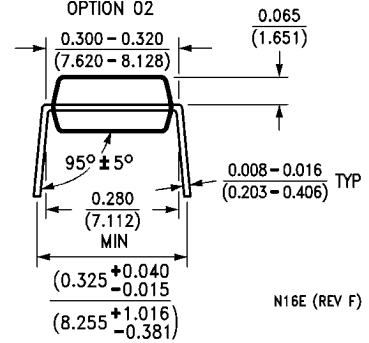
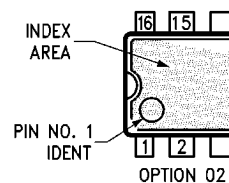
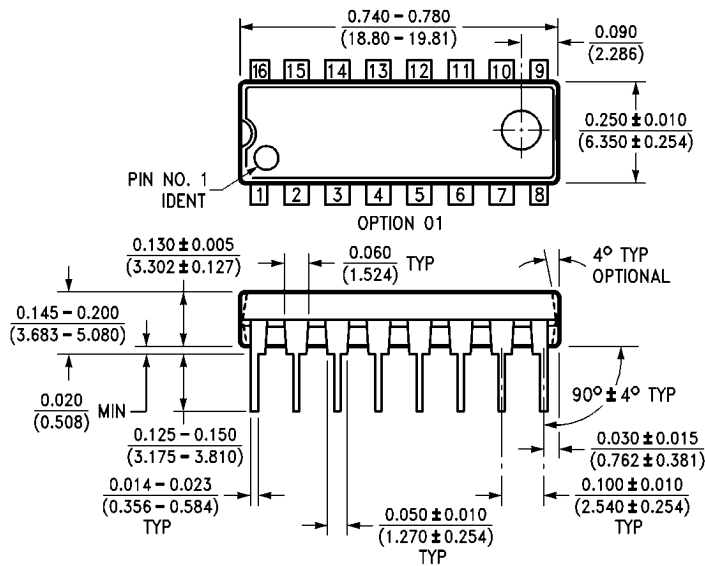
FIGURE 2. Propagation Delay TRI-STATE Control Input to Output

Physical Dimensions inches (millimeters) unless otherwise noted



M16A (REV H)

SO Package (M)
Order Number DS3486M
NS Package Number M16A



N16E (REV F)

Molded Dual-In-Line Package (N)
Order Number DS3486N
NS Package Number N16E

Notes

Notes

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS. PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2007 National Semiconductor Corporation

For the most current product information visit us at www.national.com



**National Semiconductor
Americas Customer
Support Center**
Email:
new.feedback@nsc.com
Tel: 1-800-272-9959

**National Semiconductor Europe
Customer Support Center**
Fax: +49 (0) 180-530-85-86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +49 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 8790

**National Semiconductor Asia
Pacific Customer Support Center**
Email: ap.support@nsc.com

**National Semiconductor Japan
Customer Support Center**
Fax: 81-3-5639-7507
Email: jpn.feedback@nsc.com
Tel: 81-3-5639-7560

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Mobile Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Transportation and Automotive	www.ti.com/automotive
Video and Imaging	www.ti.com/video

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated